

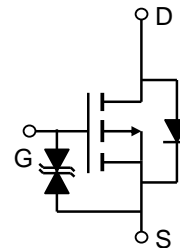
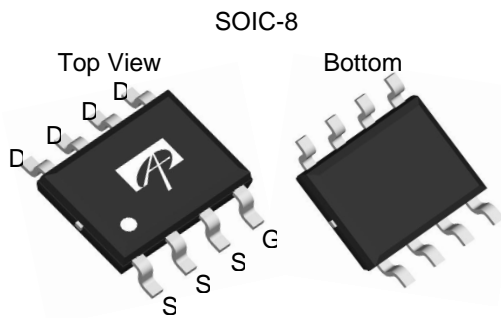
### General Description

The AO4433 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications.

### Product Summary

$V_{DS}$  (V) = -30V  
 $I_D$  = -11 A ( $V_{GS}$  = -20V)  
 $R_{DS(ON)} < 14m\Omega$  ( $V_{GS}$  = -20V)  
 $R_{DS(ON)} < 18m\Omega$  ( $V_{GS}$  = -10V)  
 $R_{DS(ON)} < 36m\Omega$  ( $V_{GS}$  = -5V)

ESD Protected  
 100% UIS Tested  
 100% Rg Tested



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter                                      | Symbol         | Maximum                | Units            |
|--|----------------|------------------------|------------------|
| Drain-Source Voltage                           | $V_{DS}$       | -30                    | V                |
| Gate-Source Voltage                            | $V_{GS}$       | $\pm 25$               | V                |
| Continuous Drain Current <sup>AF</sup>         | $I_D$          | $T_A=25^\circ\text{C}$ | -11              |
|  |                | $T_A=70^\circ\text{C}$ | -9.7             |
| Pulsed Drain Current <sup>B</sup>              | $I_{DM}$       | -50                    | A                |
| Power Dissipation <sup>A</sup>                 | $P_D$          | $T_A=25^\circ\text{C}$ | 3                |
|  |                | $T_A=70^\circ\text{C}$ | 2.1              |
| Avalanche Current <sup>B</sup>                 | $I_{AR}$       | -36                    | A                |
| Repetitive avalanche energy 0.1mH <sup>B</sup> | $E_{AR}$       | 65                     | mJ               |
| Junction and Storage Temperature Range         | $T_J, T_{STG}$ | -55 to 150             | $^\circ\text{C}$ |

### Thermal Characteristics

| Parameter                                 | Symbol          | Typ | Max | Units              |
|---|-----------------|-----|-----|--------------------|
| Maximum Junction-to-Ambient <sup>AF</sup> | $R_{\theta JA}$ | 28  | 40  | $^\circ\text{C/W}$ |
| Maximum Junction-to-Ambient <sup>A</sup>  |                 |     |     |                    |
| Maximum Junction-to-Lead <sup>C</sup>     | $R_{\theta JL}$ | 21  | 30  | $^\circ\text{C/W}$ |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions   | Min   | Typ   | Max      | Units            |
|-----------------------------|---------------------------------------|--|---|-------|----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |  |   |       |          |                  |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=-250\mu\text{A}$ , $V_{GS}=0\text{V}$   | -30   |       |          | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=-30\text{V}$ , $V_{GS}=0\text{V}$  |   |       | -1       | $\mu\text{A}$    |
|                             |                                       | $T_J=55^\circ\text{C}$   |   |       | -5       |                  |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 25\text{V}$   |   |       | $\pm 10$ | $\mu\text{A}$    |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS}=V_{GS}$ , $I_D=-250\mu\text{A}$  | -1.5  | -2.45 | -3.5     | V                |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS}=-10\text{V}$ , $V_{DS}=-5\text{V}$   | -50   |       |          | A                |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS}=-20\text{V}$ , $I_D=-11\text{A}$   |   | 11    | 14       | $\text{m}\Omega$ |
|                             |                                       | $T_J=125^\circ\text{C}$  |   | 15    | 19       |                  |
|                             |                                       | $V_{GS}=-10\text{V}$ , $I_D=-10\text{A}$   |   | 13.8  | 18       | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=-5\text{V}$ , $I_D=-5\text{A}$   |   | 25.8  | 36       | $\text{m}\Omega$ |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=-5\text{V}$ , $I_D=-11\text{A}$  |   | 20    |          | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=-1\text{A}$ , $V_{GS}=0\text{V}$  |   | -0.72 | -1       | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |  |   |       | -4.2     | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |  |   |       |          |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}$ , $V_{DS}=-15\text{V}$ , $f=1\text{MHz}$                          |   | 1760  | 2200     | pF               |
| $C_{oss}$                   | Output Capacitance                    |  |   | 360   |          | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |  |   | 255   | 357      | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$                            | 3.2   | 6.4   | 8        | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |  |   |       |          |                  |
| $Q_g$                       | Total Gate Charge                     | $V_{GS}=-10\text{V}$ , $V_{DS}=-15\text{V}$ , $I_D=-11\text{A}$                      |   | 30    | 38       | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |  |   | 7     |          | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |  |   | 8     |          | nC               |
| $t_{D(on)}$                 | Turn-On Delay Time                    | $V_{GS}=-10\text{V}$ , $V_{DS}=-15\text{V}$ , $R_L=1.5\Omega$ ,<br>$R_{GEN}=3\Omega$ |   | 11.5  |          | ns               |
| $t_r$                       | Turn-On Rise Time                     |  |   | 8     |          | ns               |
| $t_{D(off)}$                | Turn-Off Delay Time                   |  |   | 35    |          | ns               |
| $t_f$                       | Turn-Off Fall Time                    |  |   | 18.5  |          | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      |  | $I_F=-11\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ |       | 24       | 30               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=-11\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                                  |   | 16    |          | nC               |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

F: The current rating is based on the  $t \leq 10\text{s}$  junction to ambient thermal resistance rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

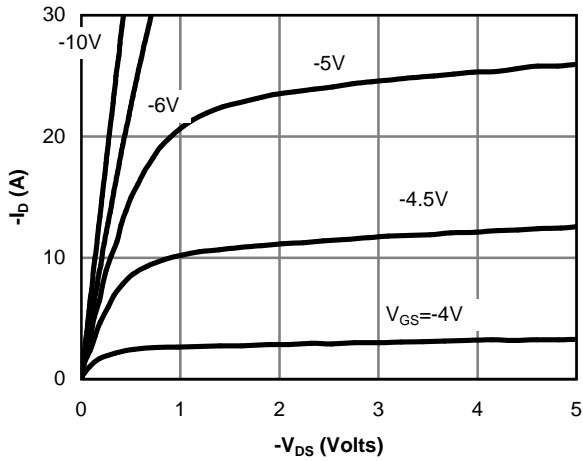


Fig 1: On-Region Characteristics

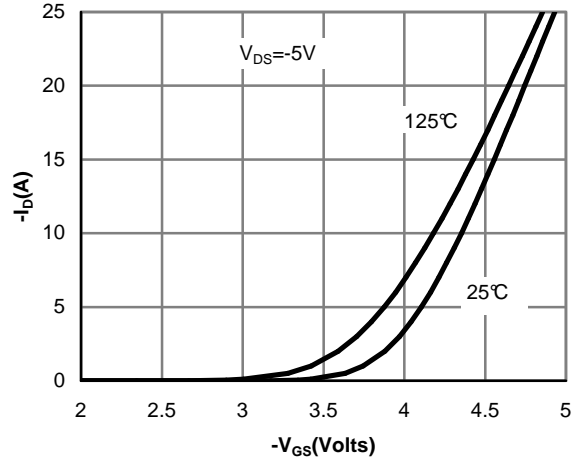


Figure 2: Transfer Characteristics

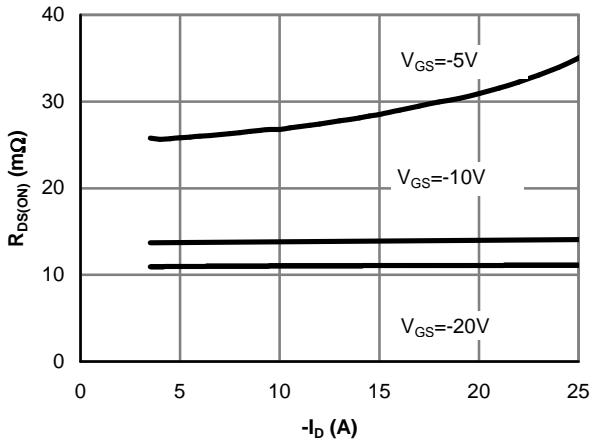


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

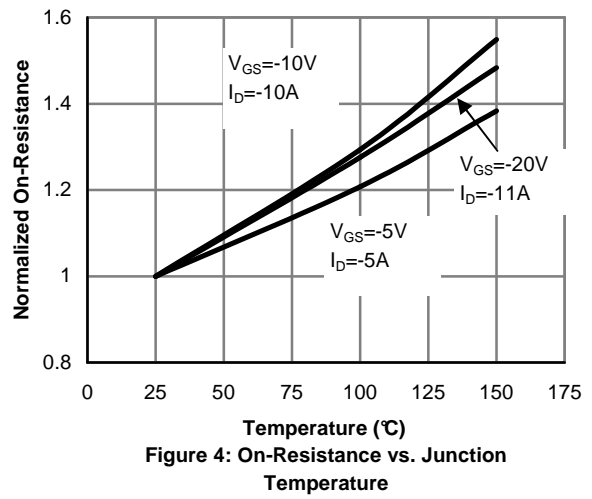


Figure 4: On-Resistance vs. Junction Temperature

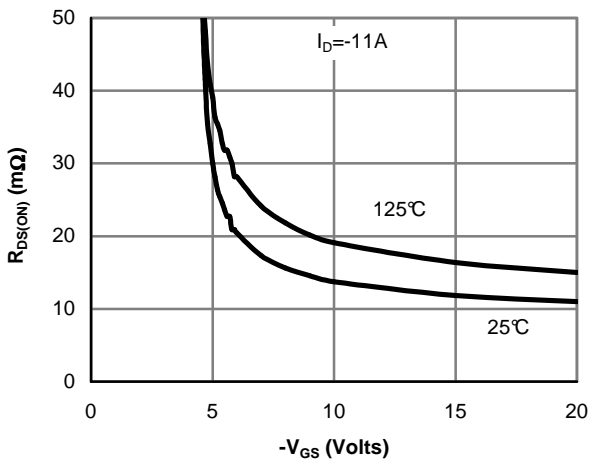


Figure 5: On-Resistance vs. Gate-Source Voltage

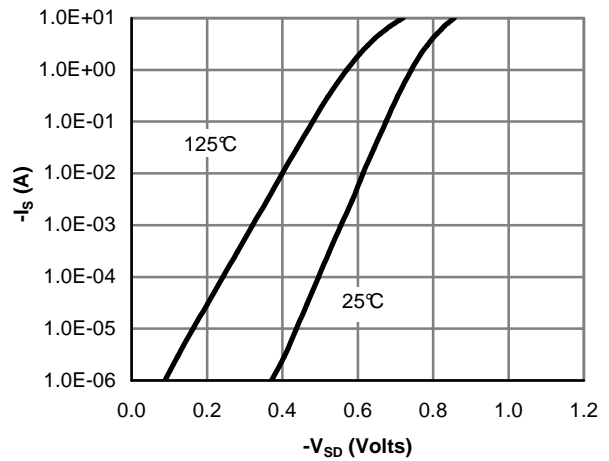


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

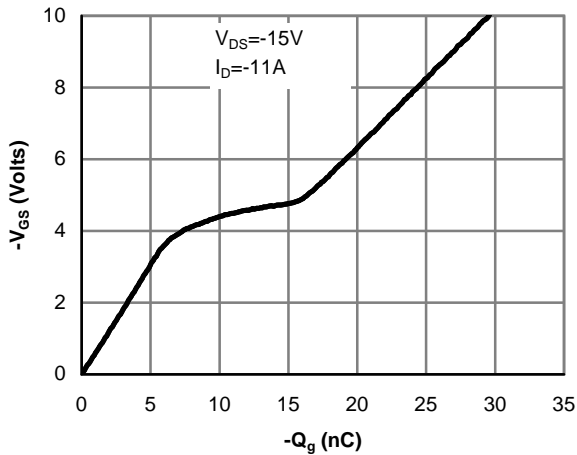


Figure 7: Gate-Charge Characteristics

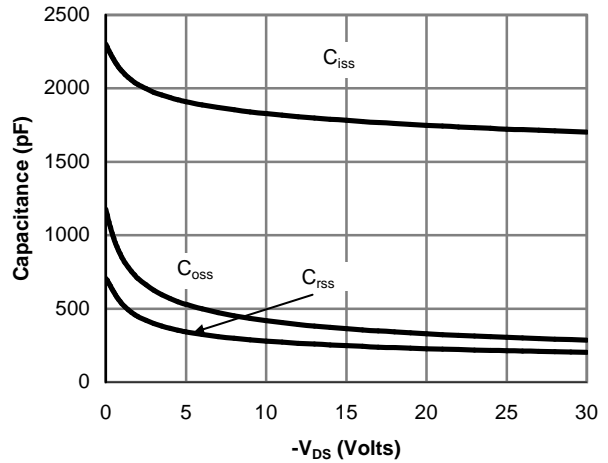


Figure 8: Capacitance Characteristics

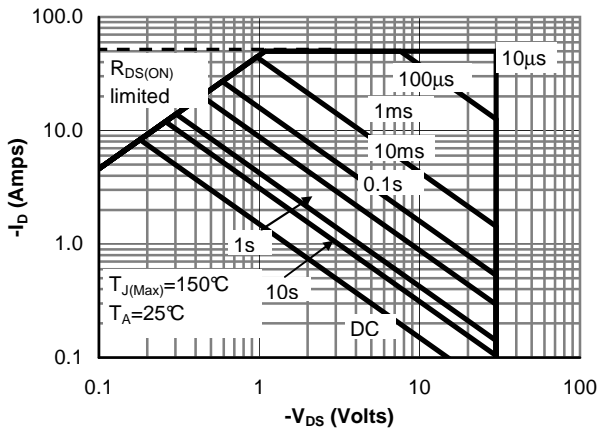


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

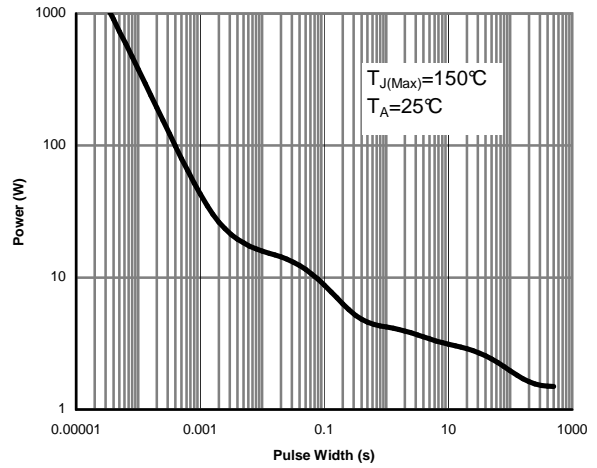


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

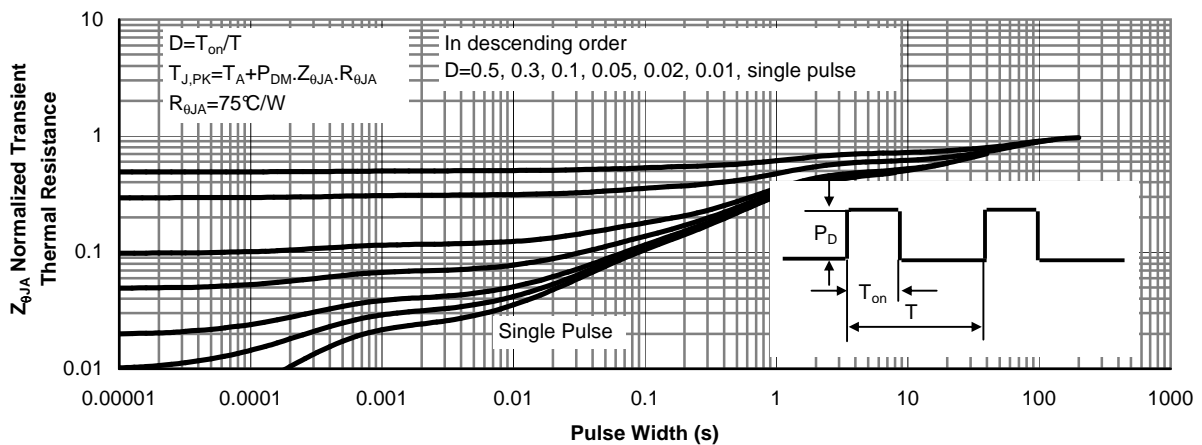
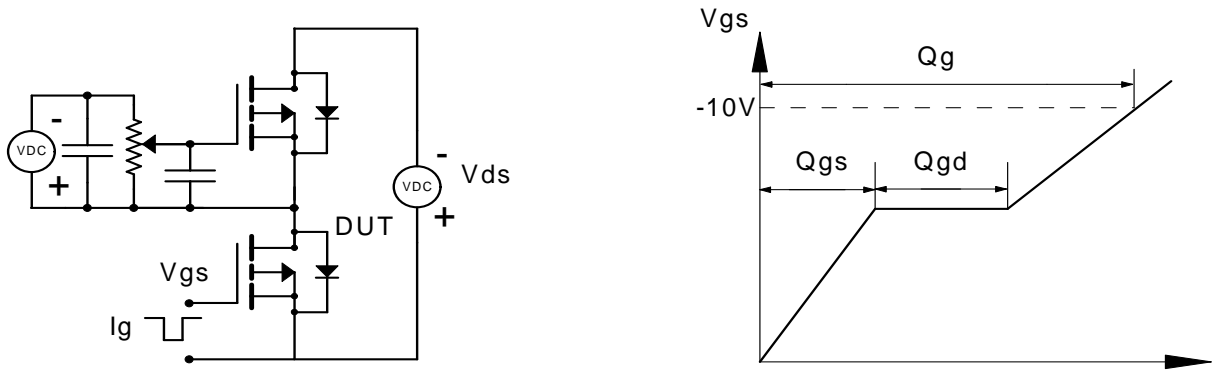
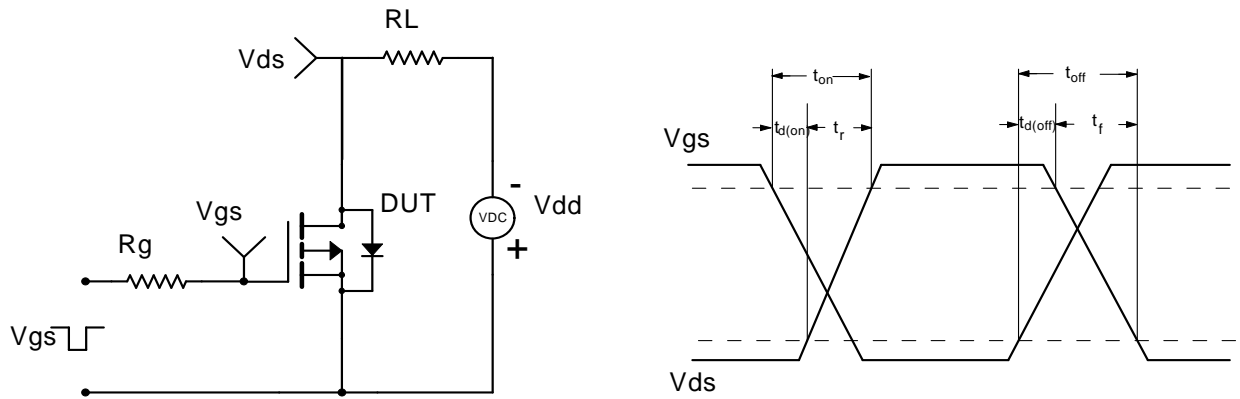


Figure 11: Normalized Maximum Transient Thermal Impedance

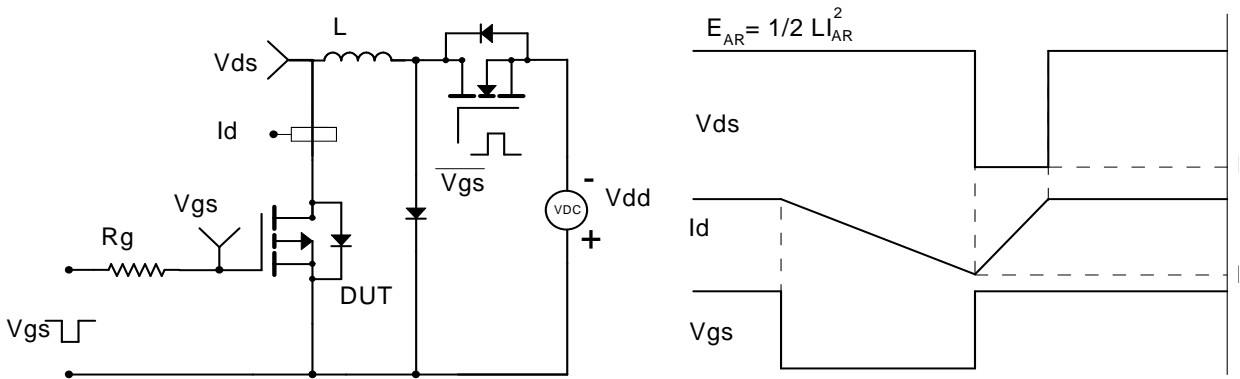
Gate Charge Test Circuit & Waveform



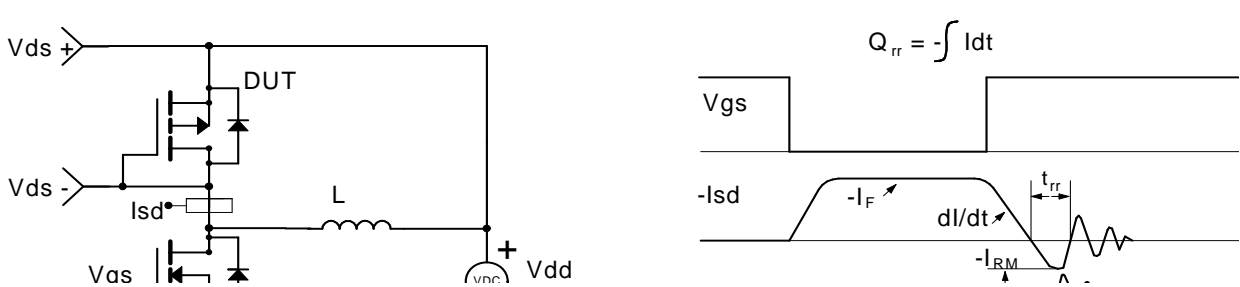
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



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